



DMP2110UVT

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
	150mΩ @ V _{GS} = -4.5V	-1.8A
-20V	200mΩ @ V _{GS} = -2.5V	-1.6A
	240mΩ @ V _{GS} = -1.8V	-1.4A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

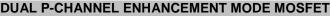
Applications

- General Purpose Interfacing Switch
- **Power Management Functions**

Top View Pin-Out





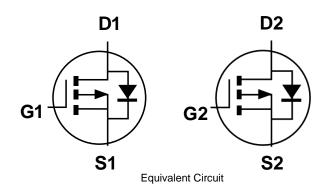


Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage •
- Low Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: TSOT26 •
- Case Material: Molded Plastic, "Green" Molding Compound. UL • Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (C3)
- Weight: 0.013 grams (Approximate)



Ordering Information (Note 4)

	Part Number	Case	Packaging		
	DMP2110UVT-7	TSOT26	3,000/Tape & Reel		
	DMP2110UVT-13	TSOT26	10,000/Tape & Reel		
Notes:	1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.				

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2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

AR7	ΥM

AR7 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Ke	у			_								
Year	2018	2019	2	020	2021	2022	2	2023	2024	202	25	2026
Code	F	G		H		J		K	L	N	1	Ν
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	-20	V
Gate-Source Voltage		V _{GSS}	±10	V
	A = +25°C A = +70°C	ID	-1.8 -1.4	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	-15	A
Body-Diode Continuous Current (Note 5)		Is	-0.7	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.74	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	168	°C/W
Total Power Dissipation (Note 6)		PD	0.74	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	1.01	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

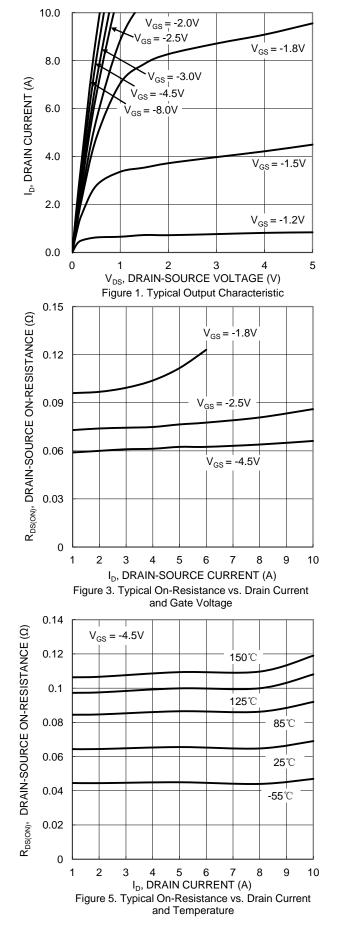
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

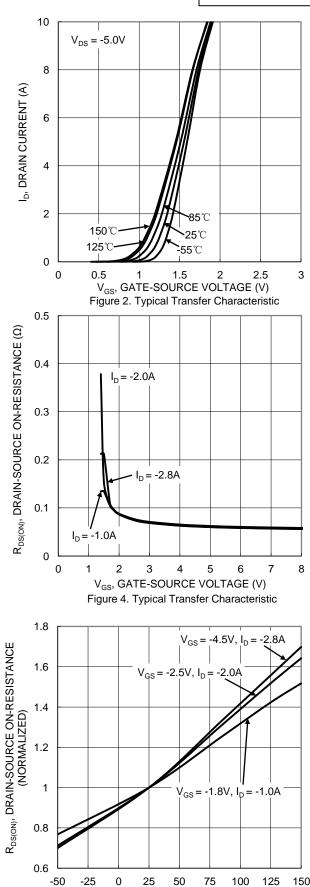
Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-20	—	_	V	V _{GS} = 0V, I _D = -250µA	
Zero Gate Voltage Drain Current TJ = +25°C	I _{DSS}		_	-1.0	μA	$V_{DS} = -16V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	—	±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	-0.45	—	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
			—	150		V _{GS} = -4.5V, I _D = -2.8A	
Static Drain-Source On-Resistance	R _{DS(ON)}	—	—	200	mΩ	V _{GS} = -2.5V, I _D = -2.0A	
	. ,		—	240		V _{GS} = -1.8V, I _D = -1.0A	
Diode Forward Voltage	V _{SD}	_	—	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		443	_	pF		
Output Capacitance	Coss		59	—	pF	−V _{DS} = -6V, V _{GS} = 0V −f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	47	_	pF	1 = 1.000112	
Gate Resistance	R _G	_	8.5	_	Ω	$V_{GS} = 0V, V_{DS} = 0V, f = 1.0MHz$	
Total Gate Charge	Qg	_	6.0		nC		
Gate-Source Charge	Q _{gs}	_	0.6	-	nC	$V_{GS} = -4.5V, V_{DS} = -10V, I_D = -3A$	
Gate-Drain Charge	Q _{qd}	_	1.8		nC		
Turn-On Delay Time	t _{D(ON)}	_	4.0	-	ns		
Turn-On Rise Time	t _R	_	3.7		ns	$V_{DS} = -10V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	24.5		ns	$R_{L} = 10\Omega, R_{G} = 1.0\Omega, I_{D} = -1A$	
Turn-Off Fall Time	tF		9.5		ns		
Reverse Recovery Time	t _{RR}		8.3		ns	I _F = -1.0A, di/dt = 100A/µs	
Reverse Recovery Charge	Q _{RR}	_	2.0	_	nC	I _F = -1.0A, di/dt = 100A/µs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:



DMP2110UVT





 $\mathsf{T}_{\mathsf{J}},$ JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Temperature

DMP2110UVT Document number: DS40891 Rev. 3 - 2



DMP2110UVT

 $I_{D} = -1mA$

50

 $\mathbf{C}_{\mathrm{iss}}$

 C_{oss}

12

8

75

100

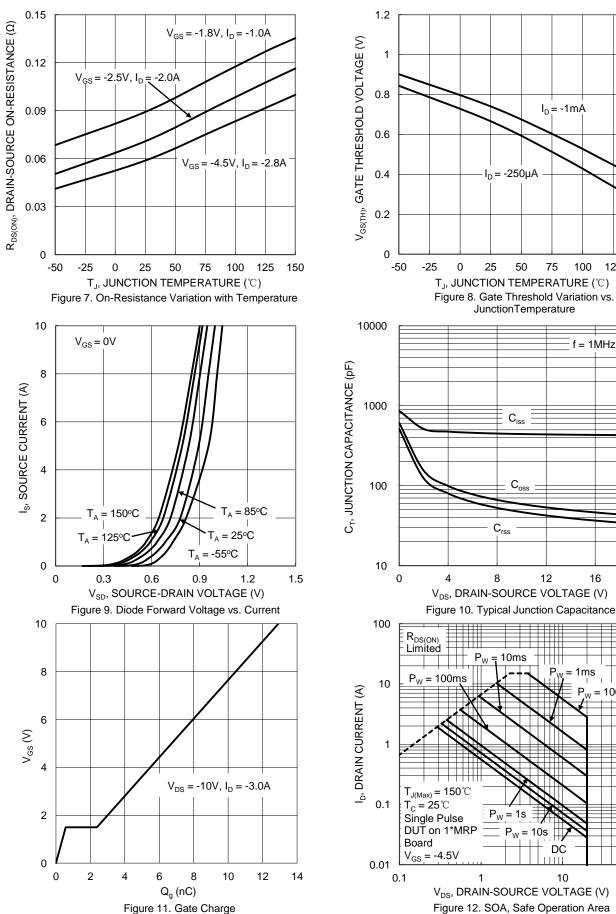
f = 1MHz

16

20

125

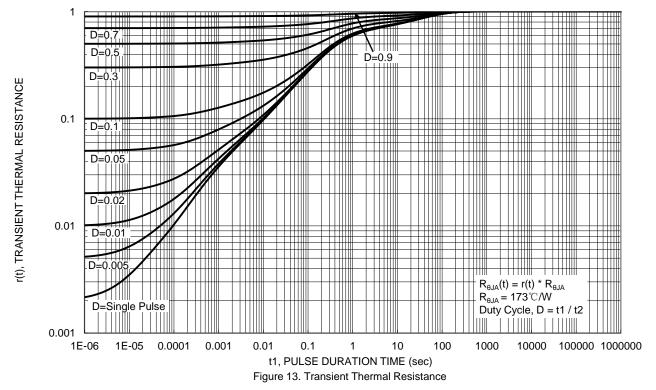
150



10ms = 1ms $P_W = 1s$ $P_W = 10s$ DC 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area

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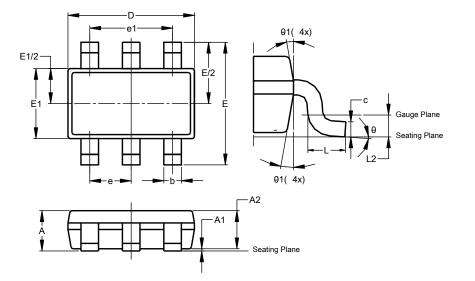




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26

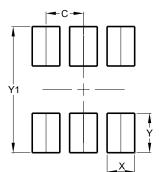


TSOT26									
Dim	Min	Тур							
Α	-	1.00	-						
A1	0.010	0.100	-						
A2	0.840	0.900	-						
D	2.800	3.000	2.900						
Е	2	2.800 BS	С						
E1	1.500	1.700	1.600						
b	0.300	0.450	-						
С	0.120	0.200	-						
е	C	0.950 BSC							
e1	1	.900 BS	С						
L	0.30	0.50 –							
L2	0.250 BSC								
θ	0°	8°	4°						
θ1	4°	12°	-						
A	II Dimen	sions in	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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